

# 190822596 Change of Package Assembly Materials and Datasheet Update

PCN Issue Date: 8/22/2019 Effective Date: 11/28/2019

PCN Type: Assembly

### **Description of Change**

Silicon Labs is announcing the following changes in assembly package materials:

- 1. Substrate to ENEPIG plating due to plating line End of Life (EOL)
- Mold compound to smaller filler size for better mold flow
- 3. Wire to Gold for better wire bondability.

As of the effective date, Silicon Labs will fulfill orders from either the existing or newly qualified package materials. Once the current assembly materials are depleted, orders will be 100% fulfilled from the new bill of material.

Silicon Labs is also announcing new datasheet revisions v1.4 and v1.2 for BGM121/BGM123 and BGM11S, respectively. Changes to the datasheet include minor typographical corrections, additional tables and descriptions. The datasheet details are listed in the documents' revision history.

### Reason for Change

Substrate plating line EOL and datasheet revisions.

## Impact on Form, Fit, Function, Quality, Reliability

There is no change on fit, function, quality or reliability. The wire is changing from copper to gold.

#### **Product Identification**

BGM121A256V2

BGM121A256V2R

BGM121N256V2

BGM121N256V2R

BGM123A256V2

BGM123A256V2R

BGM123N256V2

BGM123N256V2R

BGM11S12F256GA-V2

BGM11S12F256GA-V2R

BGM11S12F256GA-xxx

BGM11S12F256GA-xxxR

BM11S12xxxxxGA

BM11S12xxxxxGAR

BGM11S22F256GA-V2

BGM11S22F256GA-V2R

BM11S22xxxxxGA

BM11S22xxxxxGAR

Where 'xxx' represents a custom part number.

## Last Date of Unchanged Product: 11/28/2019

#### **Qualification Samples**

Available upon request.

#### **Customer Response**

Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change, Ref. JEDEC-J-STD-046.

To request further data or inquire about this notification, please contact your Silicon Labs sales representative. A list of Silicon Labs sales representatives is available at <a href="http://www.silabs.com">http://www.silabs.com</a>.

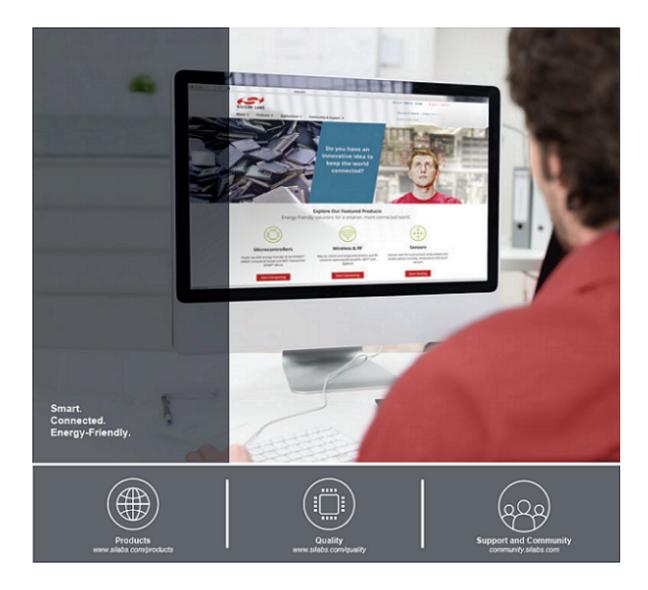
Customers may approve early PCN acceptance by emailing approval, along with PCN # to PCNEarlyAcceptance@silabs.com

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#### **Qualification Data**

Available upon request.



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